

Docket No.: H0498.70130US01

(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:

Tao Deng et al.

Serial No.:

10/763819

Confirmation No.:

5026

Filed:

January 23, 2004

For:

FABRICATION OF METALLIC MICROSTRUCTURES VIA

EXPOSURE OF PHOTOSENSITIVE COMPOSITION

Examiner:

Kathleen Duda

Art Unit:

1756

Certificate of Mailing Under 37 CFR 1.8(a)

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the U.S. Postal Service on the date shown below with sufficient postage as First Class Mail, in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Dated: April 24, 2006

RESPONSE TO RESTRICTION REQUIREMENT

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In response to the restriction requirement set forth in the Office Action mailed February 24, 2006, Applicants hereby provisionally elect claims Group III, claims 23-29 for continued examination, with traverse. The traversal was made on the grounds that it is believed that a single search and examination covering all claims would not place undue burden on the Examiner.

A first and favorable action is respectfully requested. If, for any reason, the Examiner is of the opinion that a telephone conversation with the Applicants' representative would expedite

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prosecution, the Examiner is kindly invited to contact the undersigned at (617) 646-8000.

Dated: 4/24/06

Respectfully submitted,

By.

Robert H. Walat, Reg. No. 46,324

Timothy J. Oyer, Ph.D., Reg. No. 36,628

Federal Reserve Plaza 600 Atlantic Avenue

Boston, Massachusetts 02210-2206

Tel. (617) 646-8000